

**\***fastree 3D

## System on Chip LiDAR

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# Outline





# Rationale of a complete solution (Flash LIDAR SoC)



#### **Conclusions** (Lidar solution is collaborative)



## Outline





#### Key issues: speed, reliability

#### Automate the "sense, think and act" cycle





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# **Current solutions**

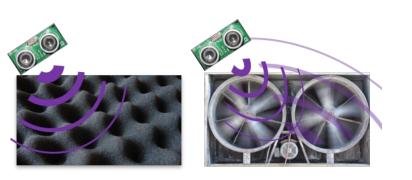
# 2D imaging

- Extreme illumination conditions
- Low contrast
- No direct depth information



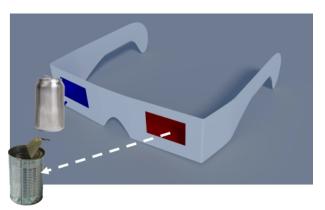
# Ultrasounds

- Slow, short range, poor spatial resolution (x,y)
- Environmentally sensitive (wind, temperature and humidity)
- No direct image



# Stereoscopy

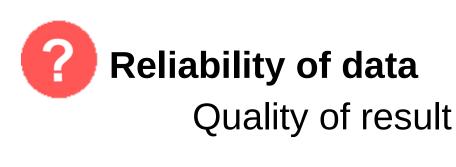
- Form-factor vs depth resolution
- Shadowing (correspondence problem)
- Heavy computation (low speed, correlation problem)

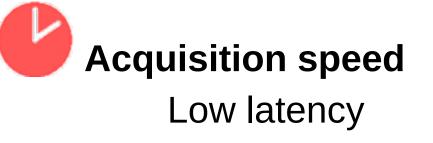




#### Improving machine vision solutions







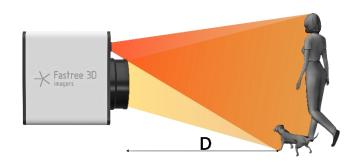
## **Complementary to image processing and stereo**

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# **Flash Lidar**

# Flash Lidar

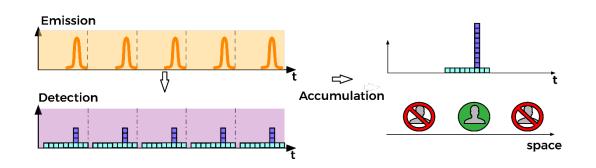
#### Single-Photon imaging



- High sensitivity
- High data throughput

TCSPC

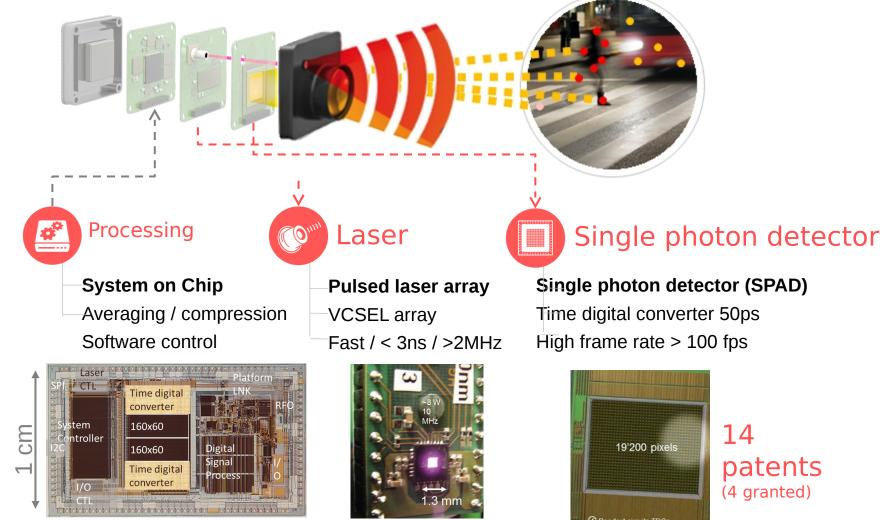
#### Time correlated measurements



- Statistical approach
- Quality of results

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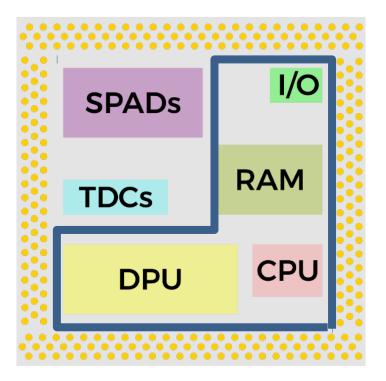
## **Fastree3D flash Lidar solution**





# System on a Chip (SoC)

# Monolithic integration



#### **†** Processing

Compression of 99.84%

## **1** Reliability

Point-cloud tagged with quality information

# **†** Flexibility

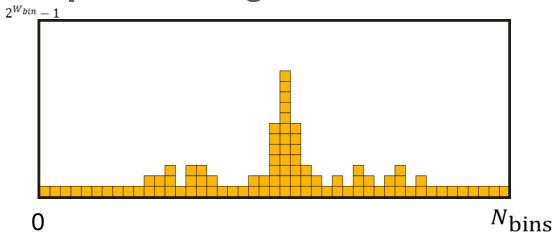
Software control over sensor



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# **Processing: compression**

# Compressed distance processing



e.g. pure histogram:  $W_{ts} = 13 \text{ bit}$   $N_{bins} = 2^{W}ts = 8192$  $W_{bin} = 8bit$ 

$$M_{\text{px}} = N_{\text{bins}} * W_{\text{bin}} = 65'536 \text{ bits}$$
  
 $M_{\text{QQVGA}} = M_{\text{px}} * 160 * 120 = 1.26\text{GB}$ 

Fastree3D processing algorithm:  

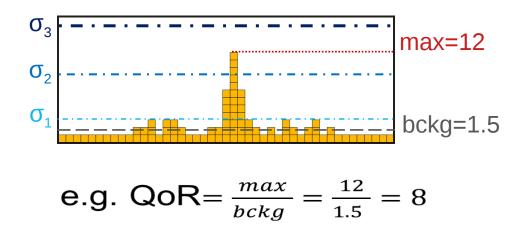
$$M_{px} = 104 \text{ bit } \Rightarrow M_{QQVGA} = M_{px} * 160 * 120 = 1.99MB$$
  
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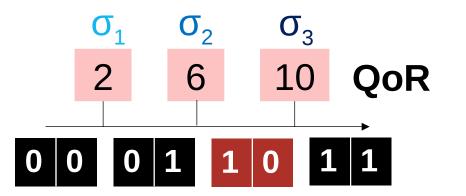


## **Reliability: Quality of Result**

#### **Distance- QoR**

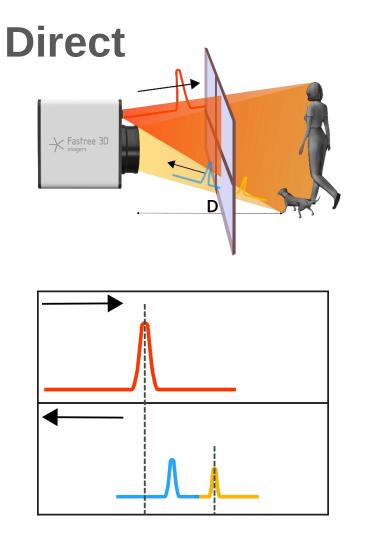
2-bit encoded  $\rightarrow$  4 possibilities







## **Reliability: interference suppression**



Multiple reflection effect:

- Create a sequence of pulses
- The back-scattered pulses are spaced over time (no overlap)
- Their intensity is proportional to the reflectivity of the objects.



# Flexibility: data format (1)

#### Distance

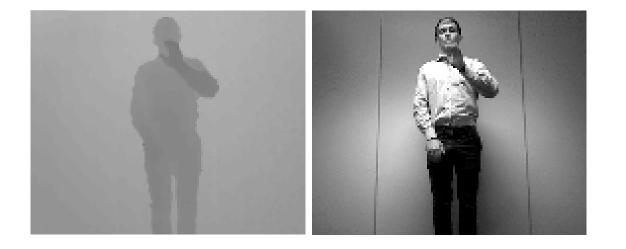


- Point cloud
- Quality of result



# Flexibility: data format (2)

#### Distance Intensity



- Photon counting
- Quality of result



# Flexibility: data format (3)

# Distance Intensity Speed

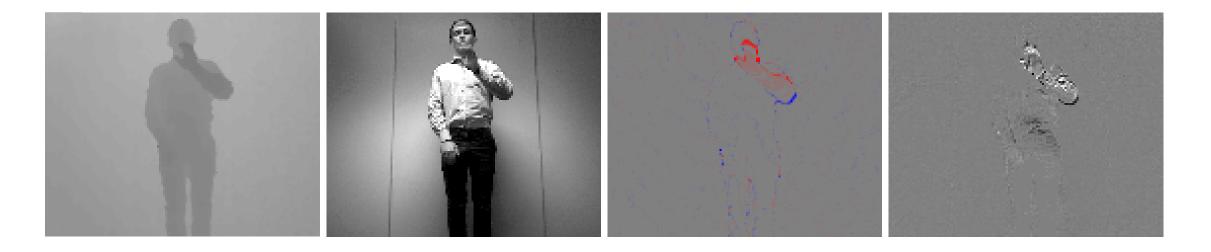


- Distance differential
- Quality of result



# **Flexibility: data format (4)**

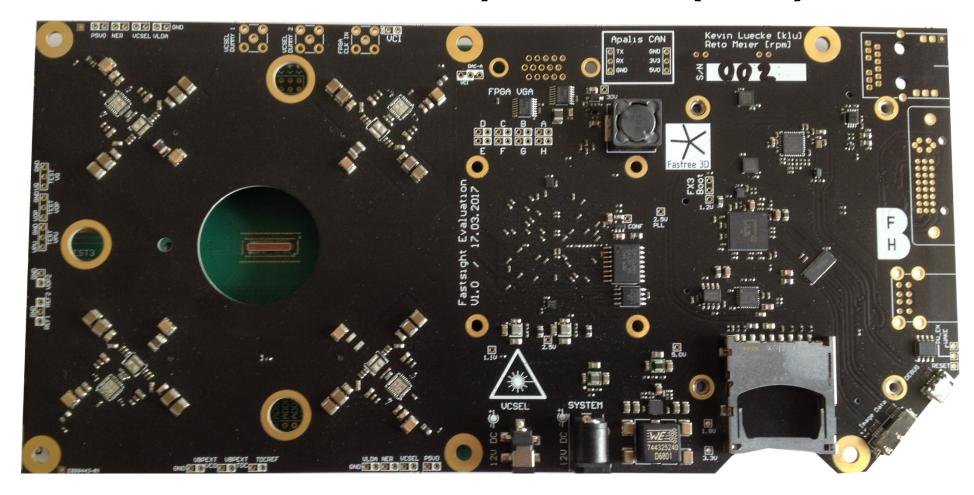
## Distance Intensity Speed Motion



- Intensity differential
- Quality of result

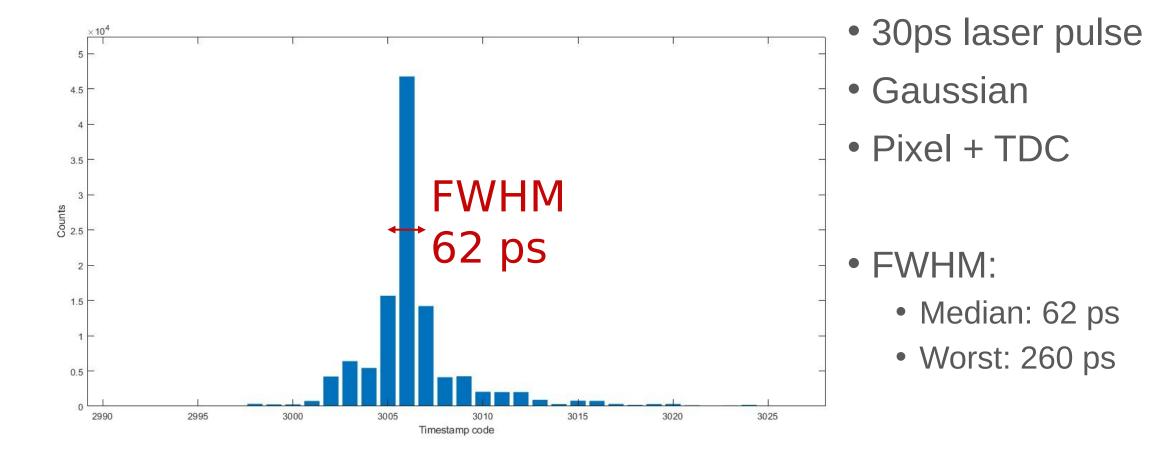


#### Fastree3D – Hardware Development Kit (HDK)



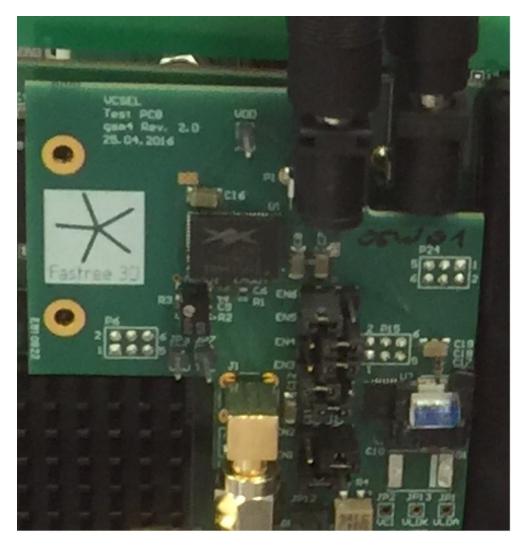


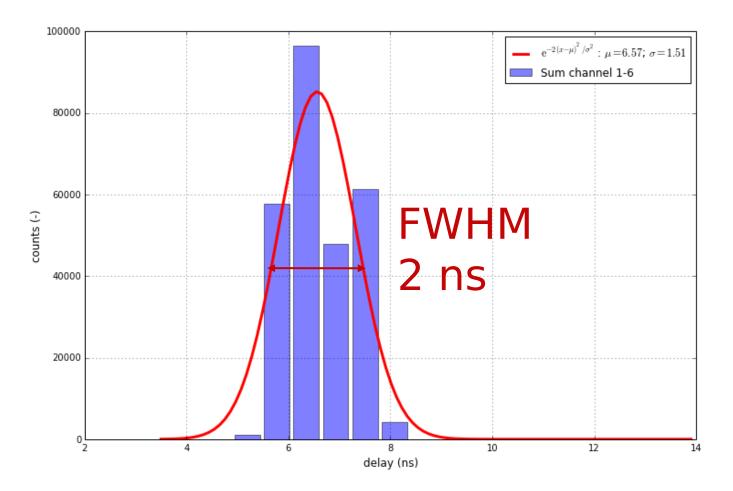
#### **Fastree3D – Sensor jitter**





#### Fastree3D – Digitally controlled laser





# Lidar technology roadmap

Line sensor 60x2 px TDC / readout Illuminator Algorithms / system Hardware development kit Partner engagement Integration System development ASIC → array

2018

Camera module LIDAR SoC - Up to QQVGA Flexible illuminators - Up to 4 sources Single board

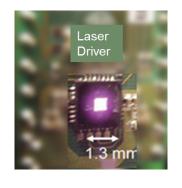
A number of the

2019

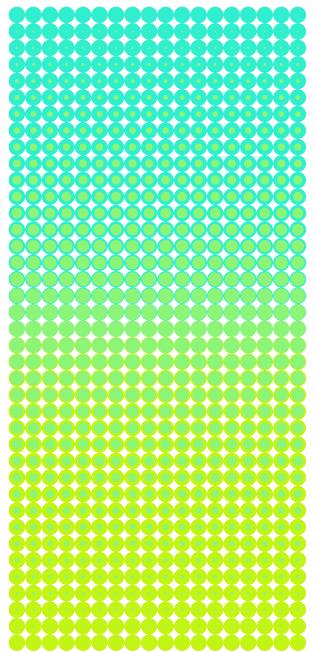
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3D stacking Performance optimization NIR → SWIR Eye safety Background rejection

2020 +



2017



## THANK YOU!



